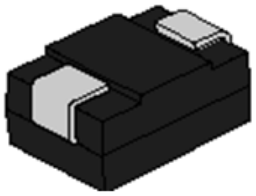
SMDJ58CAH Transient Voltage Suppressor

Rev.1.0

DESCRIPTION:

TVS diodes can be used in a wide range of applications which like consumer electronic products, automotive industries, munitions, telecommunications, aerospace industries, and intelligent control systems.



SMC

Bi-directional

Symbol

FEATURES:

- ✧ Low profile package.
- ✧ Low inductance.
- ✧ Excellent clamping capability.
- ✧ 3000W peak pulse power capability at 10/1000μs waveform.
- ✧ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.
- ✧ High temperature to reflow soldering: 260℃/40s at terminals.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260℃.
- ✧ For surface mounted applications in order to optimize board space.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ High reliability application and automotive grade (AEC-Q101 qualified).

IEC COMPATIBILITY

- ✧ ISO16750-2 P5A 12V system (90V/4Ω/200ms 10c)
- ✧ ISO16750-2 P5A 24V system (151V/8Ω/200ms 10c)

ABSOLUTE MAXIMUM RATINGS(T_A=25℃, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage and operating junction temperature range	T_{STG}/ T_J	-55 to +150	℃
Peak pulse power dissipation at 10/1000μs waveform	P_{PP}	3000	W
Steady state power dissipation at T_L=75℃	$P_{M(AV)}$	6.5	W
Typical thermal resistance junction to lead	$R_{\theta JL}$	15	℃/W
Typical thermal resistance junction to ambient	$R_{\theta JA}$	75	℃/W

MARKING

H58C: Device Marking Code
1409: In ninth week, 2014

ELECTRICAL CHARACTERISTICS(T_A=25℃)

Part Number	Marking	V_R	I_R@V_R	V_{BR}@I_T		I_T	V_C@I_{PP}	I_{PP}①
Bi-Polar	Bi	V	max(μA)	min(V)	max(V)	mA	max(V)	A
SMDJ58CAH	H58C	58	5	64.40	71.20	1	93.6	32.1

① Surge waveform: 10/1000μs

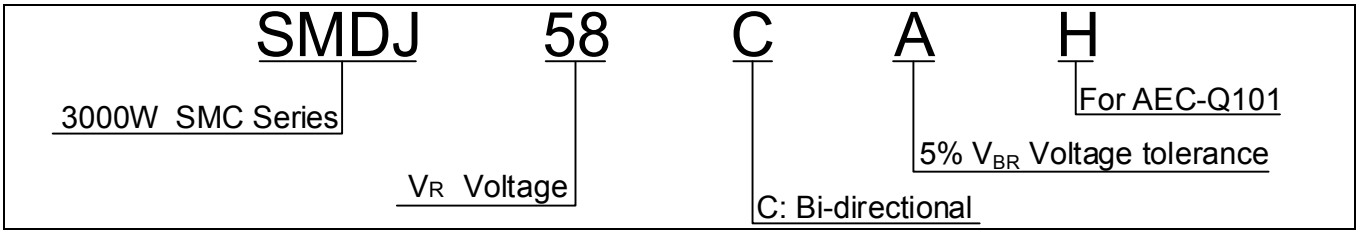
V_R: Stand-off voltage -- Maximum voltage that can be applied

V_{BR}: Breakdown voltage

V_C: Clamping voltage -- Peak voltage measured across the suppressor at a specified I_{PP}

I_R: Reverse leakage current

ORDERING INFORMATION



RATINGS AND V-I CHARACTERISTICS CURVES (T_A=25℃, unless otherwise noted)

FIG.1:V- I curve characteristics (Bi-directional)

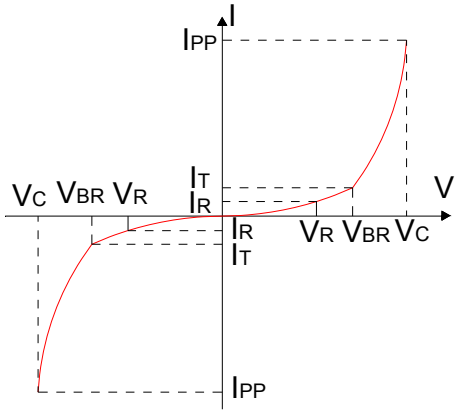


FIG.2: Pulse waveform

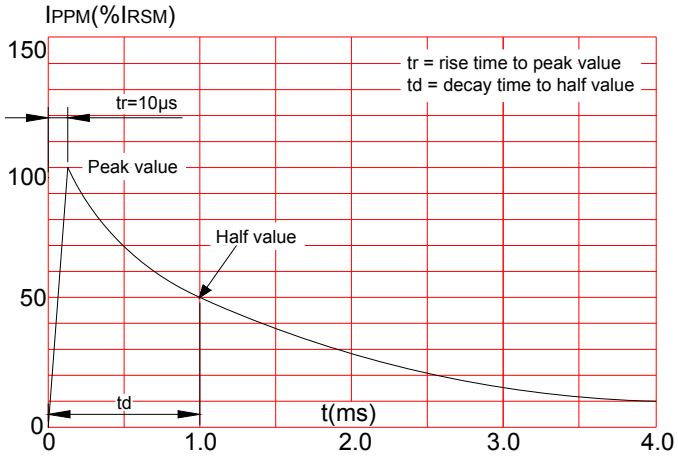


FIG.3: Pulse derating curve

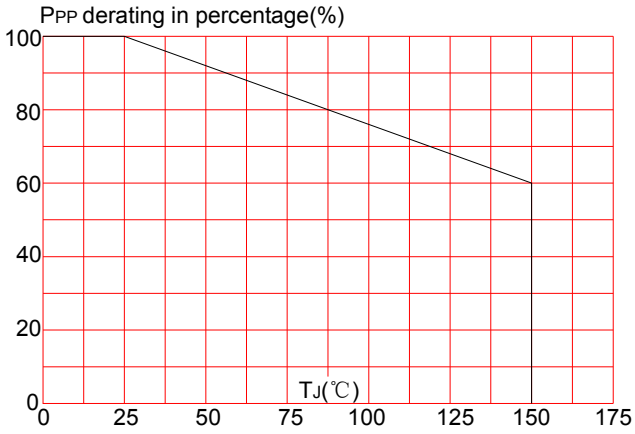


FIG.4:Peak pulse power dissipation vs. pulse width

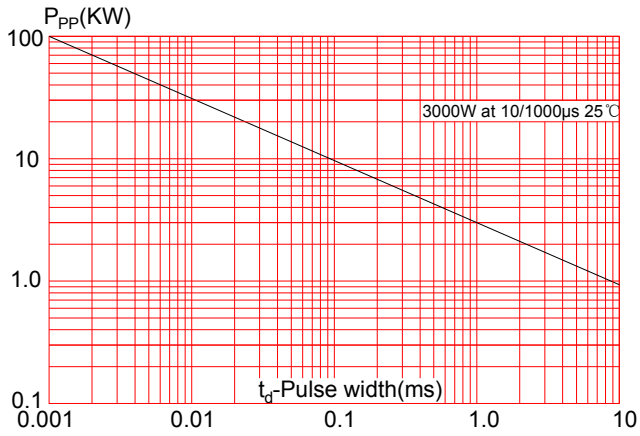


FIG.5: ISO16750 -2 test pulse 5A

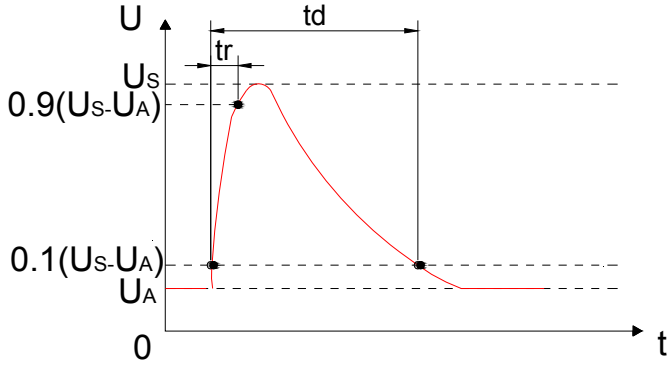
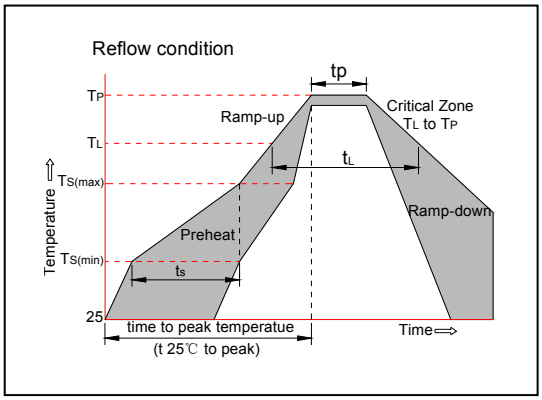


FIG.6: Parameters for test pulse 5a

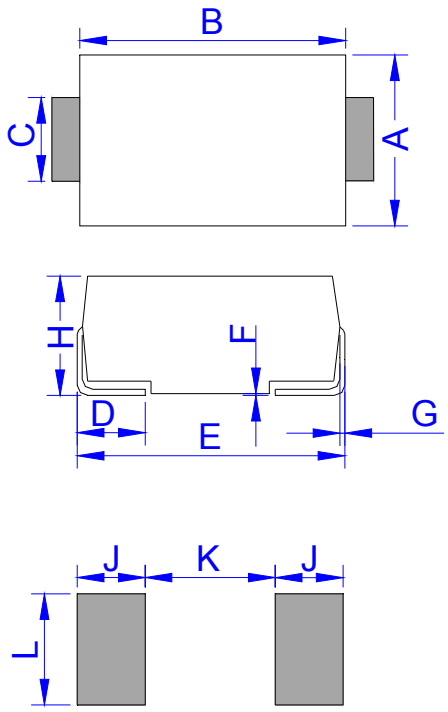
Parameter	12V system	24V system
Us	79V to 101V	151V to 202V
Ri	0.5Ω to 4Ω	1 Ω to 8Ω
td	40ms to 400ms	100ms to 350ms
tr	5-10ms	5-10ms

SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃



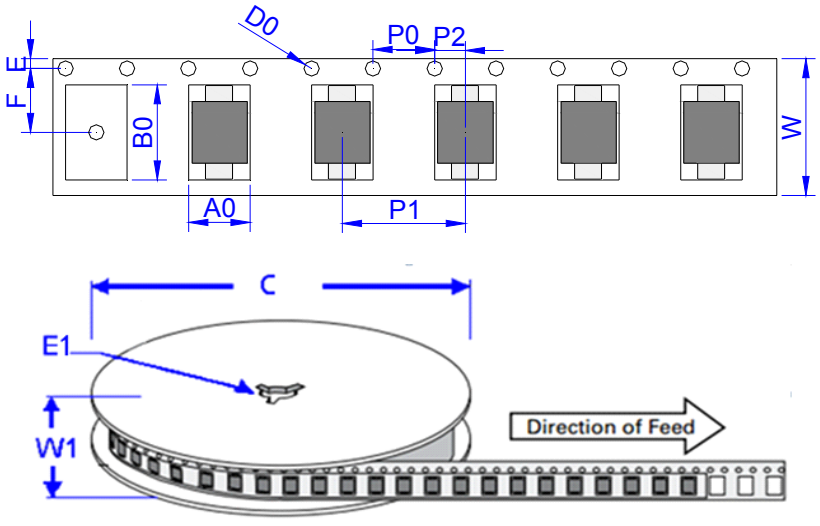
PACKAGE MECHANICAL DATA



DO-214AB (SMC)

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	5.75	6.25	0.226	0.246
B	6.90	7.40	0.272	0.291
C	2.75	3.25	0.108	0.128
D	0.95	1.52	0.037	0.060
E	7.70	8.20	0.303	0.323
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.15	2.62	0.085	0.103
J	2.40		0.094	
K		4.20		0.165
L	3.30		0.130	

TAPE AND REEL SPECIFICATION-SMC



Ref.	Dimensions	
	Millimeters	Inches
A0	6.05 ± 0.3	0.238 ± 0.012
B0	8.31 ± 0.3	0.327 ± 0.012
C	330.0	13.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	7.50 ± 0.2	0.295 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	8.00 ± 0.2	0.3145 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	16.0 ± 0.2	0.630 ± 0.008
W1	19.7 ± 2.0	0.776 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
SMDJ58CAH	0.31	3,000	48,000	13 inch reel pack

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